Notice for TAIYO YUDEN products

Please read this notice before using the TAIYO YUDEN products.

REMINDERS

Product information in this catalog is as of October 2013. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or usage of the Products.

Please note that TAIYO YUDEN CO., LTD. shall not be responsible for any defects in products or equipment incorporating such products, which are caused under the conditions other than those specified in this catalog or individual specification.

Please contact TAIYO YUDEN CO., LTD. for further details of product specifications as the individual specification is available.

Please conduct validation and verification of products in actual condition of mounting and operating environment before commercial shipment of the equipment.

All electronic components or functional modules listed in this catalog are developed, designed and intended for use in general electronics equipment.(for AV, office automation, household, office supply, information service, telecommunications, (such as mobile phone or PC) etc.). Before incorporating the components or devices into any equipment in the field such as transportation,(automotive control, train control, ship control), transportation signal, disaster prevention, medical, public information network (telephone exchange, base station) etc. which may have direct influence to harm or injure a human body, please contact TAIYO YUDEN CO., LTD. for more detail in advance.

Do not incorporate the products into any equipment in fields such as aerospace, aviation, nuclear control, submarine system, military, etc. where higher safety and reliability are especially required.

In addition, even electronic components or functional modules that are used for the general electronic equipment, if the equipment or the electric circuit require high safety or reliability function or performances, a sufficient reliability evaluation check for safety shall be performed before commercial shipment and moreover, due consideration to install a protective circuit is strongly recommended at customer's design stage.

The contents of this catalog are applicable to the products which are purchased from our sales offices or distributors (so called "TAIYO YUDEN' s official sales channel").
It is apply applied to the products our sales of TAIYO YUDEN' sofficial sales channel".

It is only applicable to the products purchased from any of TAIYO YUDEN's official sales channel.

Please note that TAIYO YUDEN CO., LTD. shall have no responsibility for any controversies or disputes that may occur in connection with a third party's intellectual property rights and other related rights arising from your usage of products in this catalog. TAIYO YUDEN CO., LTD. grants no license for such rights.

Caution for export

Certain items in this catalog may require specific procedures for export according to "Foreign Exchange and Foreign Trade Control Law" of Japan, "U.S. Export Administration Regulations", and other applicable regulations. Should you have any question or inquiry on this matter, please contact our sales staff.

TAIYO YUDEN 2014

SMD POWER INDUCTORS



PARTS NUMBER

*Operating Temp. : $-25 \sim +105^{\circ}C$ (Including self-generated heat)

1 0 0 5 0 T \triangle 1 0 0	M \triangle	
2 3 4	5 6	
	(
Series name		
Coating resin specification		
	_	
× H)	-	
Dimensions $(L \times H)$ [mm]	-	
10.0 × 5.0	3	
ackaging		
Packaging		
Taping		
	Q 3 4 Series name Coating resin specification ×H) Dimensions (L×H) [mm] 10.0 × 5.0	

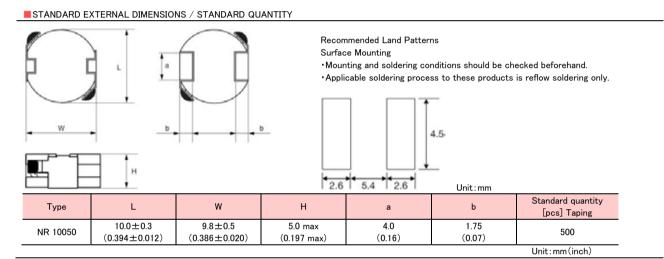
 $\Delta = Blank space$

④Nominal inductance				
Code (example)	Nominal inductance[μ H]			
1R3	1.3			
100	10			
101	100			

%R=Decimal point

⑤Inductance tolerance			
Code	Inductance tolerance		
М	±20%		
Ν	±30%		

⑥Internal code	
Code	Internal code
Δ	Standard
	otandara



PARTS NUMBER

•NR 10050 type								
	FHS	New Section 1	nal inductance [μ H] Inductance tolerance Self-resonant frequency [MHz] (min.)	Self-resonant		Rated current 💥) [mA]		Manada
Parts number				DC Resistance $[\Omega](\pm 30\%)$	Saturation current Idc1	Temperature rise current Idc2	Measuring frequency[kHz]	
NR 10050T 1R3N	RoHS	1.3	±30%	53	0.0068	11,000	9,000	100
NR 10050T 2R1N	RoHS	2.1	±30%	37	0.0080	10,000	8,300	100
NR 10050T 2R9N	RoHS	2.9	±30%	29	0.0093	8,200	7,300	100
NR 10050T 3R8N	RoHS	3.8	±30%	26	0.013	7,300	6,800	100
NR 10050T 4R9N	RoHS	4.9	±30%	23	0.015	6,600	6,000	100
NR 10050T 6R5N	RoHS	6.5	±30%	19	0.018	6,000	5,200	100
NR 10050T 100M	RoHS	10	±20%	15	0.025	4,700	4,100	100
NR 10050T 150M	RoHS	15	±20%	11	0.035	3,600	3,200	100
NR 10050T 220M	RoHS	22	±20%	10	0.045	2,600	2,500	100
NR 10050T 330M	RoHS	33	±20%	8.2	0.066	2,500	2,100	100
NR 10050T 470M	RoHS	47	±20%	7.0	0.092	2,000	1,800	100
NR 10050T 680M	RoHS	68	±20%	5.6	0.144	1,700	1,500	100
NR 10050T 101M	RoHS	100	±20%	4.6	0.209	1,300	1,200	100
NR 10050T 221M	RoHS	220	±20%	3.0	0.450	1,000	800	100

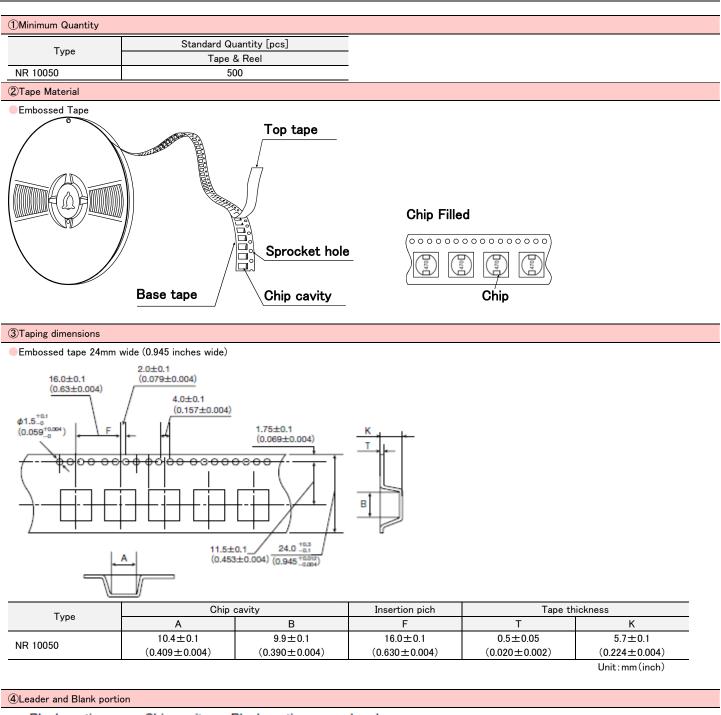
%) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C)

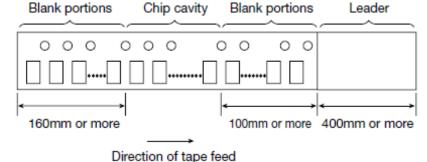
%) The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40°C. (at 20°C)

*) The maximum rated current is the DC current value that satisfies both of current value Saturation current value and temperature rise current value. (at 20°C)

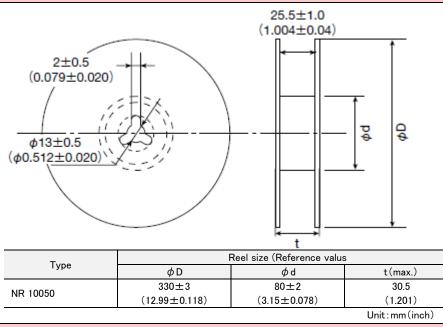
SMD POWER INDUCTORS

PACKAGING



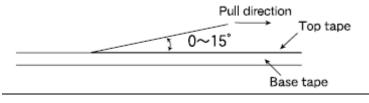






6 Top Tape Strength

The top tape requires a peel-off force of 0.1 to 1.3N in the direction of the arrow as illustrated below.





SMD inductor (NR□, NS series)

RELIABILITY DATA

1. Operating Tempo	1. Operating Temperature Range				
Specified Value	NR30/40/50/60/80, NRS20, NRV20/30, NRH24/30 Type	-25~+120°C			
	NRS40/50/60/80 Type	-25~+125°C			
	NR10050 Type	-25~+105°C			
	NS101, NS125 Type	-40~+125°C			
Test Methods and Remarks	Including self-generated heat				

2. Storage Temperature Range			
	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type		
Specified Value	NR10050 Type	40~+85°C 	
	NS101, NS125 Type		
Test Methods and Remarks	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type: -5 to 40°C for the product with taping.		

3. Rated current				
0.00	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type			
Specified Value	NR10050 Type	Within the specified tolerance		
	NS101, NS125 Type			

4. Inductance				
	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type			
Specified Value	NR10050 Type	Within the specified tolerance		
	NS101, NS125 Type			
Test Methods and Remarks	Measuring equipment : LCR Meter (HP 4285A or equivalent) Measuring frequency : Specified frequency NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type : s and Measuring equipment : LCR Meter (HP 4285A or equivalent) Measuring equipment : LCR Meter (HP 4285A or equivalent) Measuring frequency : 100kHz, 1V NR10050 Type : :			
	Measuring equipment : LCR Meter (HP 4263A or eq Measuring frequency : 100kHz, 1V	uivalent)		

5. DC Resistance				
Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Within the specified tolerance		
	NR10050 Type			
	NS101, NS125 Type			
Test Methods and Remarks	Measuring equipment : DC ohmmeter (HIOKI 3227 or equivalent)			

6. Self resonance frequency				
Specified Value	NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type	Within the specified tolerance		
	NR10050 Type	7		
	NS101, NS125 Type	_		
Test Methods and Remarks	NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type, NR10050 Type : Measuring equipment : Impedance analyzer/material analyzer(HP4291A or equivalent HP4191A, 4192A or equivalent)			



7. Temperature cha	7. Temperature characteristic				
		0/50/60/80, NRV20/30, 30, NRS20/40/50/60/80 Type	Inductance change : Within $\pm 20\%$		
Specified Value	NR10050) Туре			
	NS101, N	NS125 Type	Inductance change : Within $\pm 15\%$		
Test Methods and Remarks	Measur With re NS101, N Measure With refe	0/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60 ement of inductance shall be taken at temperature ra ference to inductance value at $+20^{\circ}$ C., change rate s NS125 Type : ment of inductance shall be taken at temperature ran, erence to inductance value at $+20^{\circ}$ C., change rate sh of maximum inductance deviation in step 1 to 5 Temperature (°C) 20 Minimum operating temperature 20 (Standard temperature) Maximum operating temperature 20	nge within $-25^{\circ}C \sim +85^{\circ}C$. shall be calculated. ge within $-40^{\circ}C \sim +125^{\circ}C$.		

8. Resistance to flexure of substrate									
0	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type			No damage					
Specified Value	NR10050 Type			_					
	NS101, NS125 Type			image					
Test Methods and Remarks		eflow. As 4/30, NF	illustrato	• •	apply force in th	o Pod	0 20 R230	Board Sample	
	Land dimension	Туре	Α	В	С	Туре	А	В	С
		NRS20, NRV20	0.65	0.7	2.0	NS101	2.5	5.6	3.2
		NRH24	0.7	0.75	2.0	NS125	2.5	8.6	3.2
		NR30, NRV30, NRH30	0.8	1.4	2.7				
		NR40, NRS40	1.2	1.6	3.7				
	ABA	NR50, NRS50	1.5	2.1	4.0				
		NR60, NRS60	1.6	3.1	5.7				
		NR80, NRS80	1.8	3.8	7.5				

9. Insulation resistance : between wires					
Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type				
	NR10050 Type	-			
	NS101, NS125 Type				

10. Insulation resist	10. Insulation resistance : between wire and core					
	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type					
Specified Value	NR10050 Type	-				
	NS101, NS125 Type					

11. Withstanding vo	11. Withstanding voltage : between wire and core					
Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type					
	NR10050 Type	-				
	NS101, NS125 Type					

12. Adhesion of terr	minal electrode				
	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type				
Specified Value	NR10050 Type		Shall not come off PC board		
	NS101, NS125 Type				
Test Methods and Remarks	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60 The test samples shall be soldered to the test board by the Applied force : 10N to X and Y directions. Duration : 5s. Solder cream thickness : 0.10mm (NR30, NRS20, NRH24 . 0.15mm (NR40/50/60/80, NRS NR10050 Type : Applied force : 5N to X and Y directions. Duration : 5s.		reflow. /30, NRV20/30)	10N, 5 s	

ation				
		Inductance change : Within $\pm 10\%$		
NR10050 Type		No significant abnormality in appearance.		
NS101, NS125 Type				
•	•	reflow.		
Total Amplitude	1.5mm (May not exceed accelera	tion 196m/s²)		
Sweeping Method	10Hz to 55Hz to 10Hz for 1min.			
Time	X Y For 2 hours on	each X, Y, and Z axis.		
	IR30/40/50/60/80, NRV IRH24/30, NRS20/40/50 IR10050 Type IS101, NS125 Type IR30/40/50/60/80, NRV The test samples shall the Then it shall be submitted Frequency Range Total Amplitude Sweeping Method	IR30/40/50/60/80, NRV20/30, IR124/30, NRS20/40/50/60/80 Type IR10050 Type IR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60 The test samples shall be soldered to the test board by the r Then it shall be submitted to below test conditions. Frequency Range 10~55Hz Total Amplitude 1.5mm (May not exceed acceleration) Sweeping Method 10Hz to 55Hz to 10Hz for 1min. X X		

14. Solderability					
	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type				
Specified Value	NR10050 Type			At least 90% of surface of terminal electrode is covered by new solder.	
	NS101, NS125 Type				
Test Methods and	Flux : Methanol solution conta	molten solder as shown in below table. /80 Type, NR10050 Type, NS101/125 Type			
Remarks	Solder Temperature	245±5°C			
	Time	5±1.0 sec.			
	XImmersion depth : All sides of mounting terminal shall be in			nersed.	



15. Resistance to s	oldering heat					
Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Inductance change : Within $\pm 10\%$				
	NR10050 Type	No significant abnormality in appearance.				
	NS101, NS125 Type					
Test Methods and Remarks	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type : The test sample shall be exposed to reflow oven at 230±5°C for 40 seconds, with peak temperature at 260±5°C for 5 seconds, 2 times. NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80Type, NS101/125 Type Test board material : glass epoxy-resin Test board thickness : 1.0mm NR10050 Type Test board material : glass epoxy-resin Test board thickness : 1.6mm					

16. Thermal shock						
0		0/50/60/80, NRV20/30, 30, NRS20/40/50/60/80 Type)	Inductance change : Within $\pm 10\%$		
Specified Value	NR10050 Type			No significant abnormality in appearance.		
	NS101, NS125 Type					
	The test	samples shall be soldered to t	he test board by the ref elow table in sequence.	/80 Type, NR10050 Type, NS101/125 Type : low. The test samples shall be placed at specified temperature for specified The temperature cycle shall be repeated 100 cycles.		
Test Methods and	Step	Temperature (°C)	Duration (min)			
Remarks	1	-40 ± 3	30±3			
	2	Room temperature	Within 3			
	3	$+85\pm2$	30 ± 3			
	4	Room temperature	Within 3			

17. Damp heat					
	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type			Inductance change : Within \pm 10% No significant abnormality in appearance.	
Specified Value	sified Value NR10050 Type		_		
	NS101, NS125 Type			Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.	
Test Methods and Remarks	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60 The test samples shall be soldered to the test board by the rest samples shall be placed in thermostatic oven set at The test samples shall be placed in thermostatic oven set at Temperature $60 \pm 2^{\circ}$ C Humidity $90 \sim 95\%$ RH			flow.	
	Time	500+24/-0 hour			

18. Loading under damp heat						
NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type		Inductance change : Within $\pm 10\%$				
NR10050 Type		No significant abnormality in appearance.				
NS101, NS125 Type						
The test samples sh The test samples s continuously as show	all be soldered to the test shall be placed in thermo wn in below table.	RS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type : board by the reflow. static oven set at specified temperature and humidity and applied the rated current				
Humidity	90~95%RH					
	Rated current $500 \pm 24/-0$ bour					
	NR30/40/50/60/80, NRH24/30, NRS20/4 NR10050 Type NS101, NS125 Type NR30/40/50/60/80, The test samples sh The test samples show The test samples as the test samples as the test samples as the test samples are test	$\begin{tabular}{lllllllllllllllllllllllllllllllllll$				

19. Low temperatur	e life test					
0	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type			Inductance change : Within $\pm 10\%$		
Specified Value	NR10050 Type			No significant abnormality in appearance.		
	NS101, NS125 Type					
Test Methods and Remarks	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type : The test samples shall be soldered to the test board by the reflow. After that, the test samples shall be placed at test conditions as shown in below table.					
	Temperature	-40±2°C				
	Time	500+24/-0 hour				

20. High temperatur	re life test			
	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type			
Specified Value	NR10050 Type			
	NS101, NS125 Type			-
T . M	NR10050 Type :			
Test Methods and Remarks	Temperature	105±3°C		
	Time	500+24/-0 hour		
Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs		tion after the test, followed by the measurement within 48hrs.		

21. Loading at high	temperature life test			
	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type			Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.
Specified Value	NR10050 Type			-
	NS101, NS125 Type			Inductance change : Within \pm 10% No significant abnormality in appearance.
	NR30/40/50/60/80,	NRV30, NRH24/30, NRS4	0/50/60/80 Ty	ре, NS12555, NS12565, NS12575 Туре :
Test Methods and	The test samples sha	ples shall be soldered to the test board by the reflow soldering.		
Remarks	Temperature	85±2°C		
	Applied current	Rated current		
	Time	500+24/-0 hour		

22. Standard condit	22. Standard condition		
	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Standard test condition : Unless otherwise specified, temperature is 20±15°C and 65±20%of relative humidity. When there is any question concerning measurement result: In order to provide correlation data, the test shall be condition of 20±2°C of temperature, 65±5% relative humidity. Inductance is in accordance with our measured value.	
	NR10050 Type		
Specified Value	NS101, NS125 Type		



PRECAUTIONS

1. Circuit Design	
Precautions	 Operating environment The products described in this specification are intended for use in general electronic equipment, (office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems,) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance.

2. PCB Design	
Precautions	 ◆Land pattern design 1. Please refer to a recommended land pattern.
Technical considerations	 Land pattern design Surface Mounting Mounting and soldering conditions should be checked beforehand. Applicable soldering process to this products is reflow soldering only.

3. Considerations	3. Considerations for automatic placement		
Precautions	 Adjustment of mounting machine 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards. 2. Mounting and soldering conditions should be checked beforehand. 		
Technical considerations	 Adjustment of mounting machine 1. When installing products, care should be taken not to apply distortion stress as it may deform the products. 		

4. Soldering	
Precautions	 Reflow soldering Please contact any of our offices for a reflow soldering, and refer to the recommended condition specified. The product shall be used reflow soldering only. Please do not add any stress to a product until it returns in normal temperature after reflow soldering. Lead free soldering When using products with lead free soldering, we request to use them after confirming adhesion, temperature of resistance to soldering heat, soldering etc sufficiently. Recommended conditions for using a soldering iron (NR10050 Type) Put the soldering iron on the land-pattern. Soldering iron's temperature - Below 350°C Duration - 3 seconds or less The soldering iron should not directly touch the inductor.
Technical considerations	 Reflow soldering If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products.

5. Cleaning	5. Cleaning	
Precautions	 Cleaning conditions 1. Washing by supersonic waves shall be avoided. 	
Technical considerations	 Cleaning conditions 1. If washed by supersonic waves, the products might be broken. 	

6. Handling	
Precautions	 Handling Keep the product away from all magnets and magnetic objects. Breakaway PC boards (splitting along perforations) When splitting the PC board after mounting product, care should be taken not to give any stresses of deflection or twisting to the board. Board separation should not be done manually, but by using the appropriate devices. Mechanical considerations Please do not give the product any excessive mechanical shocks. Please do not add any shock and power to a product in transportation. Pick-up pressure Please do not push to add any pressure to a winding part. Please do not give any shock and push into a ferrite core exposure part. Packing Please avoid accumulation of a packing box as much as possible.
Technical considerations	 Handling There is a case that a characteristic varies with magnetic influence. Breakaway PC boards (splitting along perforations) The position of the product on PCBs shall be carefully considered to minimize the stress caused from splitting of the PCBs. Mechanical considerations There is a case to be damaged by a mechanical shock. There is a case to be broken by the handling in transportation. Pick-up pressure Damage and a characteristic can vary with an excessive shock or stress. Packing If packing boxes are accumulated, that could cause a deformation on packing tapes or a damage on the products.

Precautions	 ◆Storage To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. Recommended conditions
Technical	 Storage 1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes
considerations	and deterioration of taping/packaging materials may take place.

